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February 1997
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NC7ST02
TinyLogic® HST 2-Input NOR Gate

General Description

The NC7ST02 is a single 2-Input high performance CMOS NOR Gate, with TTL-compatible inputs. Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation. ESD protection diodes inherently guard both inputs and output with respect to the V_{CC} and GND rails. High gain circuitry offers high noise immunity and reduced sensitivity to input edge rate. The TTL-compatible inputs facilitate TTL to NMOS/CMOS interfacing. Device performance is similar to MM74HCT but with ½ the output current drive of HC/HCT.

Features

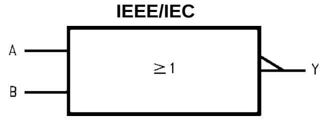
- Space saving SOT23 or SC70 5-lead package
- Ultra small MicroPak™ leadless package
- High Speed; t_{PD} < 7 ns typ, V_{CC} = 5V, C_L = 15 pF
- Low Quiescent Power; I_{CC} < 1 µA typ, V_{CC} = 5.5V
- Balanced Output Drive; 2 mA I_{OL}, −2 mA I_{OH}
- TTL-compatible inputs

Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7ST02M5X	MA05B	8S02	5-Lead SOT23, JEDEC MO-178, 1.6mm	3k Units on Tape and Reel
NC7ST02P5X	MAA05A	T02	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3k Units on Tape and Reel
NC7ST02L6X	MAC06A	D9	6-Lead MicroPak, 1.0mm Wide	5k Units on Tape and Reel

Logic Symbol

IEEE/IEC



Pin Descriptions

Pin Names	Description
A, B	Inputs
Y	Output
NC	No Connect

Function Table

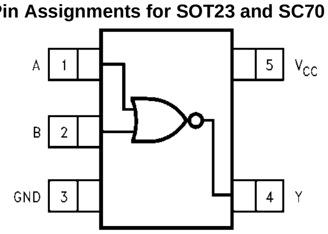
$Y = \overline{A + B}$

Inputs		Output
A	**B**	**Y**
L	L	H
L	H	L
H	L	L
H	H	L

H = HIGH Logic Level L = LOW Logic Level

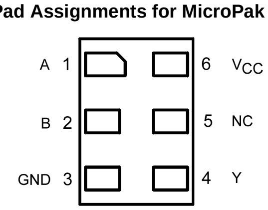
Connection Diagrams

Pin Assignments for SOT23 and SC70



(Top View)

Pad Assignments for MicroPak



(Top Thru View)

Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Input Diode Current (I_{IK})	
$V_{IN} < -0.5V$	−20 mA
$V_{IN} \geq V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V_{IN})	−0.5V to V_{CC} +0.5V
DC Output Diode Current (I_{OK})	
$V_{OUT} < -0.5V$	−20 mA
$V_{OUT} > V_{CC} + 0.5V$	+20 mA
Output Voltage (V_{OUT})	−0.5V to V_{CC} +0.5V
DC Output Source or Sink Current (I_{OUT})	±12.5 mA
DC V_{CC} or Ground Current per Supply Pin (I_{CC} or I_{GND})	±25 mA
Storage Temperature (T_{STG})	−65°C to +150°C
Junction Temperature (T_J)	150°C
Lead Temperature (T_L); (Soldering, 10 seconds)	260°C
Power Dissipation (P_D) @+85°C	
SOT23-5	200 mW
SC70-5	150 mW

Recommended Operating Conditions (Note 2)

Supply Voltage	4.5V to 5.5V
Input Voltage (V_I)	0V to V_{CC}
Output Voltage (V_O)	0V to V_{CC}
Operating Temperature (T_A)	−40°C to +85°C
Input Rise and Fall Time (t_r,t_f)	
V_{CC} = 5.0V	0 to 500 ns
Thermal Resistance (θ_{JA})	
SOT23-5	300°C/W
SC70-5	425°C/W

Note 1: Absolute Maximum Ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of circuits outside the databook specifications.

Note 2: Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

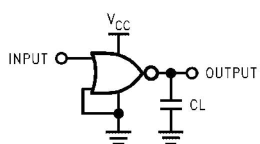
Symbol	Parameter	V_{CC} (V)	T_A = +25°C			T_A = −40°C to +85°C		Units	Conditions
			Min	Typ	Max	Min	Max		
V_{IH}	HIGH Level Input Voltage	4.5–5.5	2.0			2.0		V	
V_{IL}	LOW Level Input Voltage	4.5–5.5			0.8		0.8	V	
V_{OH}	HIGH Level Output Voltage	4.5	4.4	4.5		4.4		V	I_{OH} = −20 µA; $V_{IN} = V_{IL}$
		4.5	4.18	4.35		4.13			I_{OH} = −2 mA
V_{OL}	LOW Level Output Voltage	4.5		0	0.1		0.1	V	I_{OL} = 20 µA; $V_{IN} = V_{IH}$
		4.5		0.10	0.26		0.33		I_{OL} = 2 mA
I_{IN}	Input Leakage Current	5.5			±0.1		±1.0	µA	$0 \leq V_{IN} \leq 5.5V$
I_{CC}	Quiescent Supply Current	5.5			1.0		10.0	µA	$V_{IN} = V_{CC}$ or GND
I_{CCT}	I_{CC} per Input	5.5			2.0		2.9	mA	One Input V_{IN} = 0.5V or 2.4V, Other Input V_{CC} or GND

AC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	$T_A = +25°C$ Min	Typ	Max	$T_A = -40°C$ to $+85°C$ Min	Max	Units	Conditions	Figure Number
t_{PLH}, t_{PHL}	Propagation Delay	5.0		3.5	12			ns	$C_L = 15$ pF	Figures 1, 3
				6.3	17					
		4.5		6.1	16		20	ns	$C_L = 50$ pF	
				11.7	27		31			
		5.5		4.2	14		18			
				11.4	26		30			
t_{TLH}, t_{THL}	Output Transition Time	5.0		4	10			ns	$C_L = 15$ pF	Figures 1, 3
		4.5		11	25		31	ns	$C_L = 50$ pF	
		5.5		10	21		26			
C_{IN}	Input Capacitance	Open		2	10			pF		
C_{PD}	Power Dissipation Capacitance	5.0		6				pF	(Note 3)	Figure 2

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I_{CCD}) at no output loading and operating at 50% duty cycle. (See Figure 2.) C_{PD} is related to I_{CCD} dynamic operating current by the expression:
$I_{CCD} = (C_{PD}) (V_{CC}) (f_{IN}) + (I_{CCstatic})$.

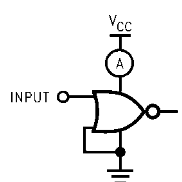
AC Loading and Waveforms



C_L includes load and stray capacitance

Input PRR = 1.0 MHz, $t_w = 500$ ns

FIGURE 1. AC Test Circuit



Input = AC Waveform; PRR = Variable; Duty Cycle = 50%

FIGURE 2. I_{CCD} Test Circuit

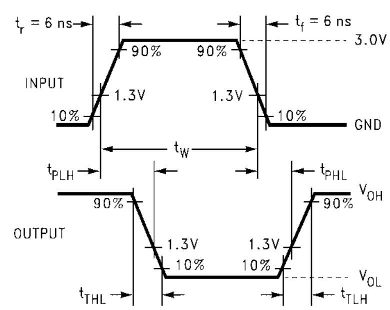


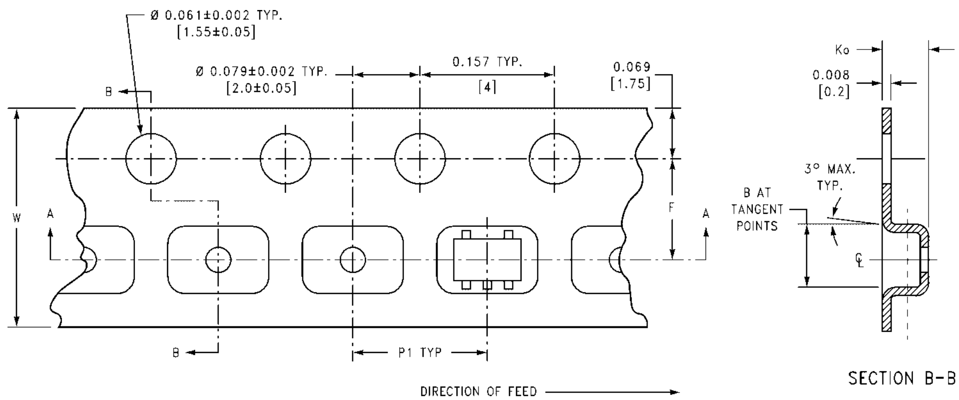
FIGURE 3. AC Waveforms

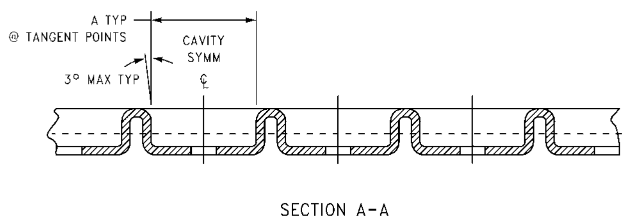
Tape and Reel Specification

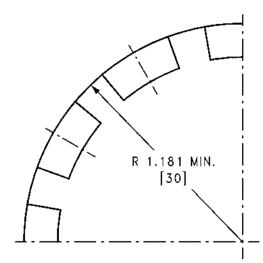
TAPE FORMAT for SC70 and SOT23

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
M5X, P5X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)







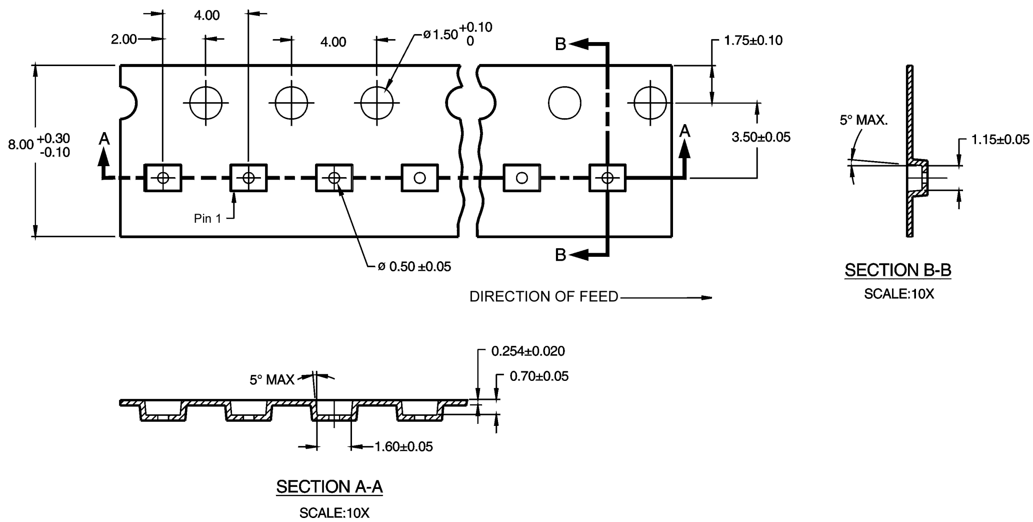
BEND RADIUS NOT TO SCALE

Package	Tape Size	DIM A	DIM B	DIM F	DIM K_o	DIM P1	DIM W
SC70-5	8 mm	0.093 (2.35)	0.096 (2.45)	0.138 ± 0.004 (3.5 ± 0.10)	0.053 ± 0.004 (1.35 ± 0.10)	0.157 (4)	0.315 ± 0.004 (8 ± 0.1)
SOT23-5	8 mm	0.130 (3.3)	0.130 (3.3)	0.138 ± 0.002 (3.5 ± 0.05)	0.055 ± 0.004 (1.4 ± 0.11)	0.157 (4)	0.315 ± 0.012 (8 ± 0.3)

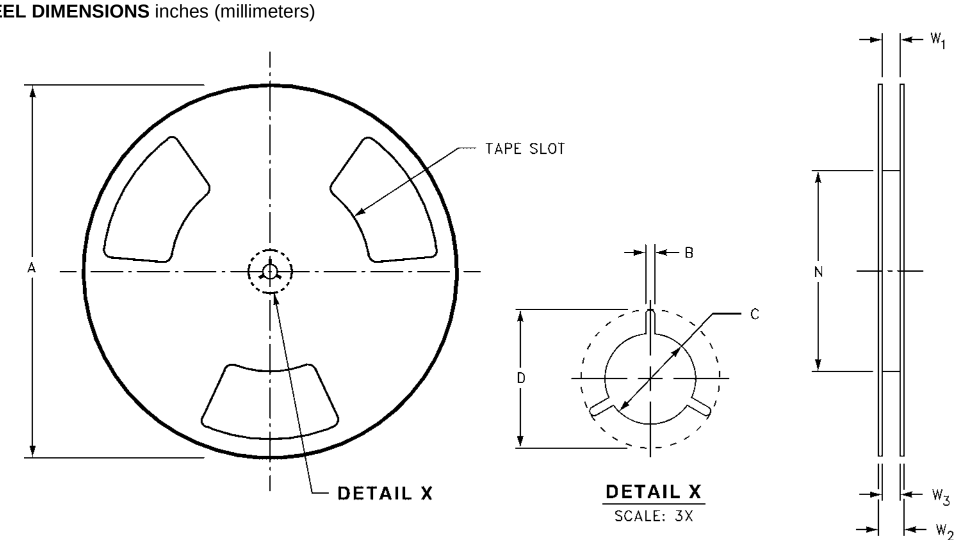
Tape and Reel Specification (Continued)

TAPE FORMAT for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L6X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

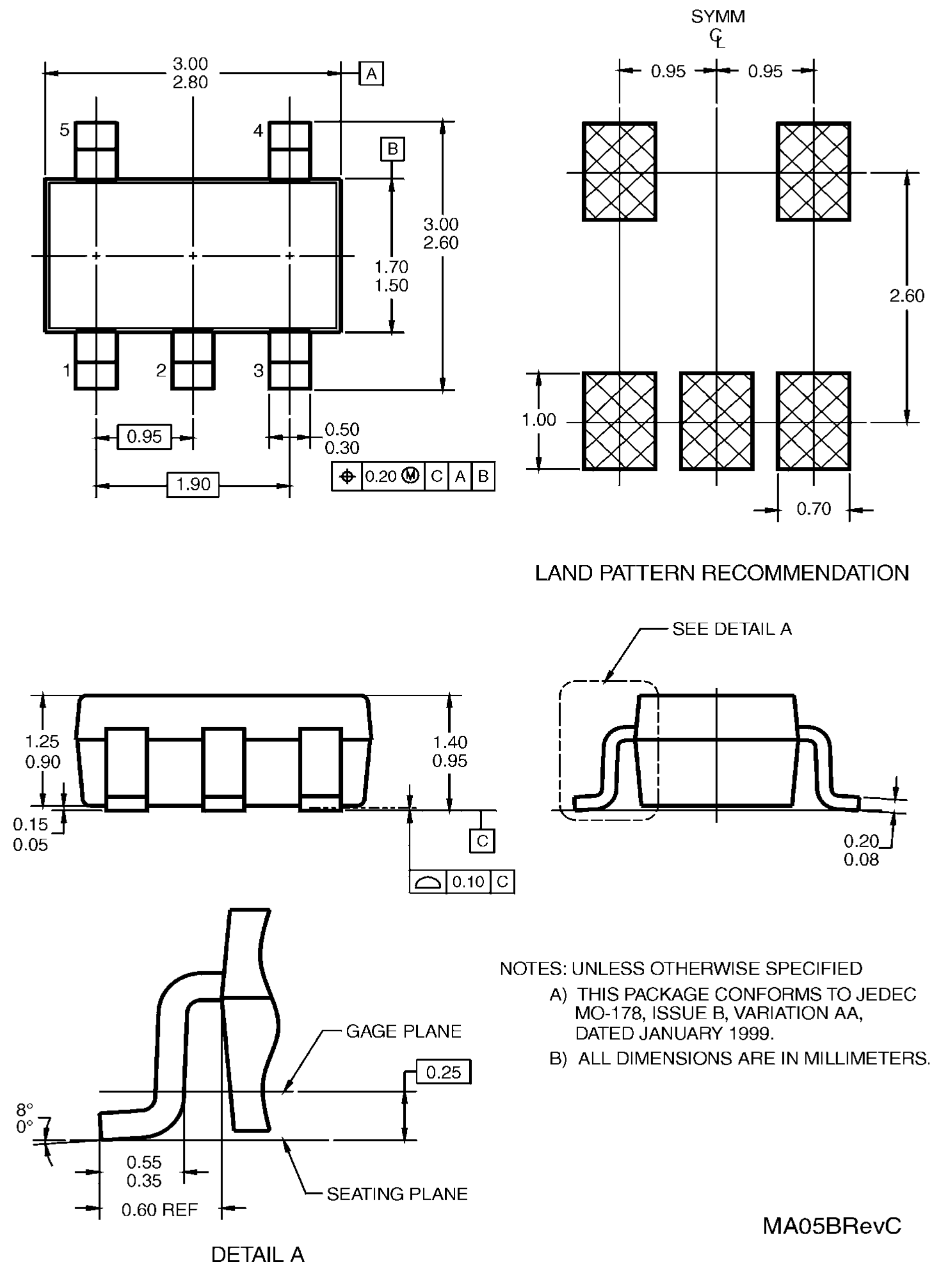


REEL DIMENSIONS inches (millimeters)



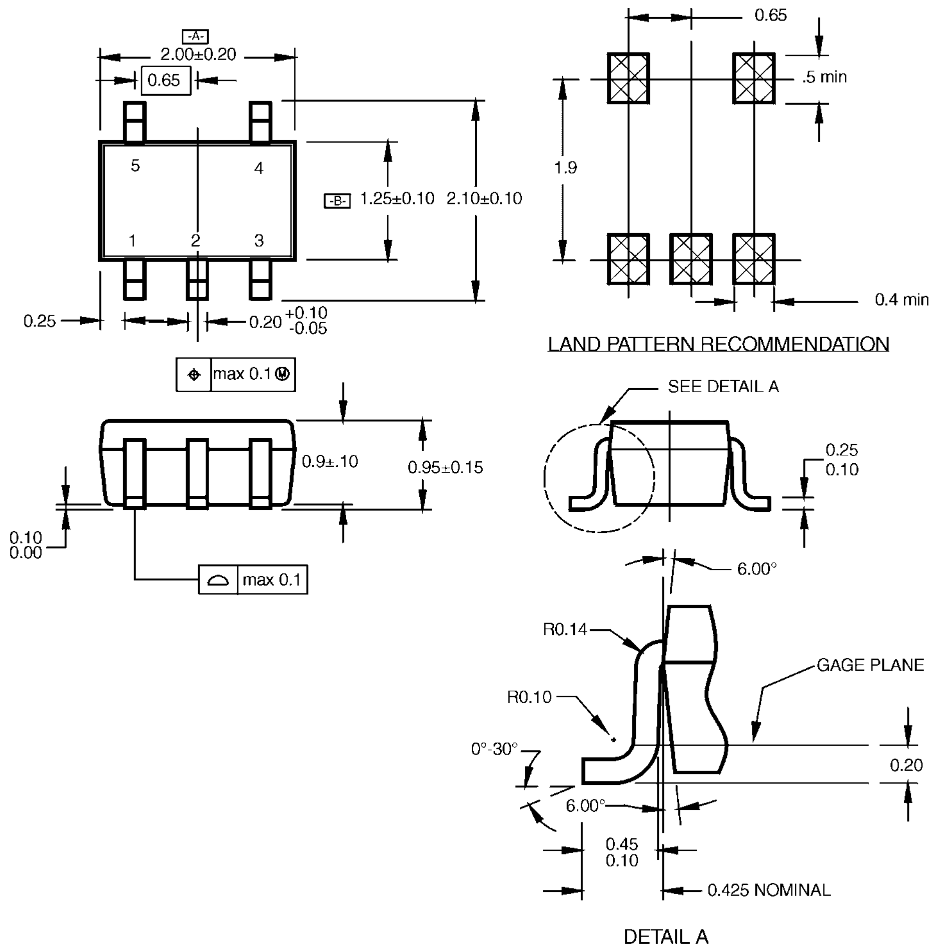
Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/–0.000 (8.40 + 1.50/–0.00)	0.567 (14.40)	W1 + 0.078/–0.039 (W1 + 2.00/–1.00)

Physical Dimensions inches (millimeters) unless otherwise noted



5-Lead SOT23, JEDEC MO-178, 1.6mm
Package Number MA05B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



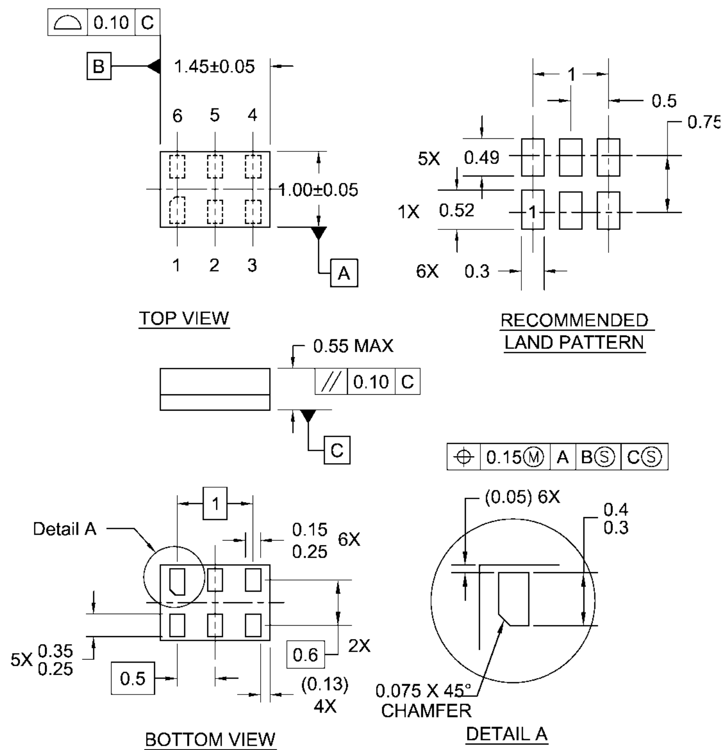
NOTES:

A. CONFORMS TO EIAJ REGISTERED OUTLINE DRAWING SC88A.
B. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
C. DIMENSIONS ARE IN MILLIMETERS.

MAA05ARevC

5-Lead SC70, EIAJ SC-88a, 1.25mm Wide
Package Number MAA05A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. JEDEC PACKAGE REGISTRATION IS ANTICIPATED
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994

MAC06ARevB

6-Lead MicroPak, 1.0mm Wide
Package Number MAC06A

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